STARPOWER

SEMICONDUCTORTM

IGBT

GD35FFK120C5S

Molding Type Module

1200V/35A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low V_{CE(sat)} NPT IGBT technology
- 10µs short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Absolute Maximum Ratings T_C =25°C unless otherwise noted

Symbol	Description	GD35FFK120C5S	Units
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	±20	V
T	Collector Current @ T _C =25 ℃	65	Α
I_{C}	@ T _C =80°C	35	A
$I_{\text{CM}(1)}$	Pulsed Collector Current t _p =1ms	70	A
I_{F}	Diode Continuous Forward Current @ T _C =80°C	35	A
$I_{FM(1)}$	Diode Maximum Forward Current t _p =1ms	70	A
P_D	Maximum Power Dissipation @ T _j =150°C	284	W
T_{jmax}	Maximum Junction Temperature	150	$^{\circ}\mathbb{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\mathbb{C}$
$V_{\rm ISO}$	Isolation Voltage RMS,f=50Hz,t=1min	2500	V
Mounting Torque	Mounting Screw:M5	3.0 to 6.0	N.m

Notes:

Electrical Characteristics of IGBT T_C =25 $^{\circ}$ C unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	T _j =25℃	1200			V
I_{CES}	Collector Cut-Off Current	$V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$ $T_{\text{j}}=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0V,$ $T_i=25^{\circ}C$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold Voltage	I_{C} =250 μ A, V_{CE} = V_{GE} , T_{j} =25 $^{\circ}$ C	4.4	4.8	6.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C}=35A, V_{GE}=15V, T_{j}=25^{\circ}C$		2.40	2.85	V
		I_{C} =35A, V_{GE} =15V, T_{j} =125°C	2.80		,	

⁽¹⁾ Repetitive rating: Pulse width limited by max. junction temperature

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t _{d(on)}	Turn-On Delay Time			270		ns
$t_{\rm r}$	Rise Time			54		ns
$t_{d(off)}$	Turn-Off Delay Time	V		273		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V,I_{C}=35A,$		178		ns
Eon	Turn-On Switching Loss	$R_G=24\Omega, V_{GE}=\pm 15V,$ $T_j=25$ °C		3.71		mJ
$E_{\rm off}$	Turn-Off Switching Loss			2.00		mJ
$t_{d(on)}$	Turn-On Delay Time			270		ns
$t_{\rm r}$	Rise Time	1		54		ns
$t_{d(off)}$	Turn-Off Delay Time	V 600VI 25A		300		ns
$t_{\rm f}$	Fall Time	$V_{CC}=600V,I_{C}=35A, \\ R_{G}=24\Omega,V_{GE}=\pm15V, \\ T_{j}=125^{\circ}C$ $V_{CE}=30V,f=1MHz, \\ V_{GE}=0V$		325		ns
Eon	Turn-On Switching Loss			4.52		mJ
$E_{ m off}$	Turn-Off Switching Loss			3.91		mJ
Cies	Input Capacitance			3.48		nF
Coes	Output Capacitance			0.28		nF
C _{res}	Reverse Transfer Capacitance			0.11		nF
I_{SC}	SC Data	$T_P \le 10 \mu s, V_{GE} = 15 V,$ $T_j = 125 ^{\circ}C, V_{CC} = 900 V,$ $V_{CEM} \le 1200 V$		320		A
L _{CE}	Stray Inductance			60		nН
R _{CC'+EE'}	Module Lead Resistance, Terminal To Chip			4.4		mΩ

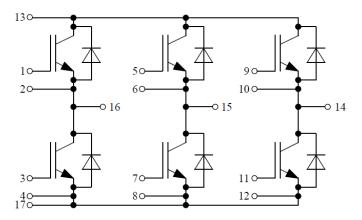
Electrical Characteristics of DIODE $T_C=25\,^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward	I _25 A	$T_j=25^{\circ}C$		2.05	2.45	17
	Voltage	$I_F=35A$	T _j =125 ℃		2.10		V
Qr	Recovered		T _i =25 ℃		1.7		C
	Charge	$I_F=35A$,	T _i =125℃		4.3		μC
I_{RM}	Peak Reverse	$V_R = 600V$,	T _i =25 ℃		27		٨
	Recovery Current	$R_G=24\Omega$,	$T_j=125$ °C		29		Α
E_{rec}	Reverse Recovery	$V_{GE}=-15V$	T _i =25 ℃		1.16		mI
	Energy		$T_j=125$ °C		2.18		mJ

Thermal Characteristics

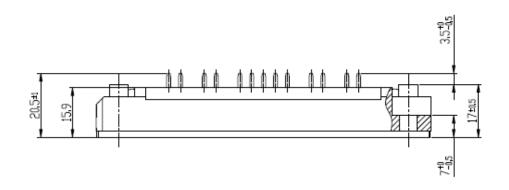
Symbol	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case (per IGBT)		0.44	K/W
$R_{ heta JC}$	Junction-to-Case (per DIODE)		0.98	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.02		K/W
Weight	Weight of Module	200		g

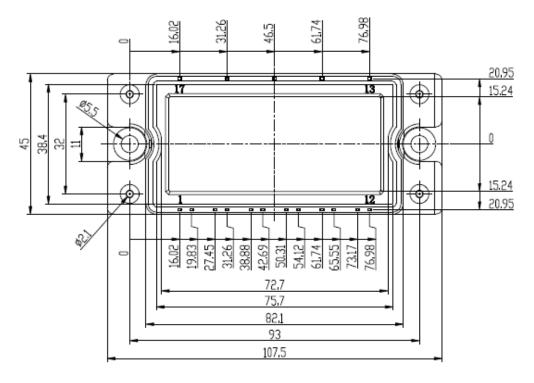
Equivalent Circuit Schematic



Package Dimension

Dimensions in Millimeters





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